USSN: 10/539,886

IN THE SPECIFICATION

Please amend the paragraph appearing on page 7, lines 3-8 as follows:

The adhesion of the vibration plate (60) and the single crystal plate (80) may be, alternatively, achieved by forming an electrode layer of a conductive metal such as aluminum, copper and gold on the <u>each</u> surface of the vibration plate (60) and the single crystal plate (80), e.g., by a sputtering or electron beam evaporation method; combining the two electrode layers of the vibration plate and the single crystal; and pressurizing the resulting laminate at an elevated temperature, e.g., from 100 to 600 °C. —